

Conference Board

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Scope

COINS is the premier conference devoted to omni-layer techniques for smart IoT systems, by identifying new perspectives and highlighting impending research issues and challenges. Topics of interest include, but are not limited to, the following:

Track 1: Internet of Things: From Device, to Edge, and Cloud Track 2: Omni-Layer Security, Privacy, and Trust Track 3: Omni-layer Reliability in IoT Era Track 4: VLSI, EDA, Embedded Systems, and Computer Architecture Track 5: Real-time Systems Track 6: Alternative and Approximate Computing Track 7: Cloud Computing Track 8: Programming Language and Software Engineering Track 9: Big Data Track 10: Artificial Intelligence, Machine Learning, Cognitive Computing, and Advanced Analytics Track 11: Computer Vision, Image Processing and Pattern Recognition Track 12: Automation Systems Track 13: Automotive Systems Track 14: Intelligent IoT eHealth Track 15: Enterprise Architecture

Proceeding & Submission Guidelines

COINS is sponsored by **IEEE Council on Electronic Design Automation (CEDA)**., The proceeding will be published in **ACM**. Accepted papers are allowed six pages in the conference proceedings free of charge. Each additional page beyond six pages is subject to the page charge at 150 Euro per page up to the eight-page limit.

Extended versions of selected best papers will be published in a special issue of the ISI indexed Elsevier journal "Microprocessors and Microsystems: Embedded Hardware Design" (**MICPRO**) having the 2016 Impact Factor as high as 1.025

In order to conduct a blind review, <u>no indication of the authors' names should appear in the</u> manuscript, references included.

Important Dates

Grant

Submission Deadline: December 1, 2018 Notification Date: January 15, 2019 Camera-ready: January 31, 2019 Conference Dates: May 5-7, 2019 COINS Executive Committee is pleased to announce registration grants for highly skilled students who have an accepted paper. We are especially looking forward to applications from Middle East, and Asia.